



2020 Interplanetary Small Satellite Conference

Thermal Toolbox Elements for Lunar/Planetary Extreme Environments

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Approved for Unlimited Release

Science Payload Thermal Control in Extreme Environments

We want to use one of these ...

Carrying one or more of these ...

To operate and stay within temperature limits, in Extreme Environments such as these ...

Using a thermal control architecture that is ...

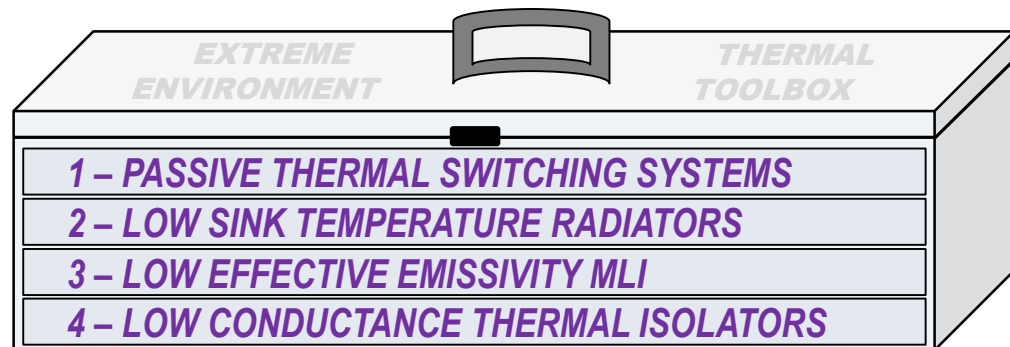
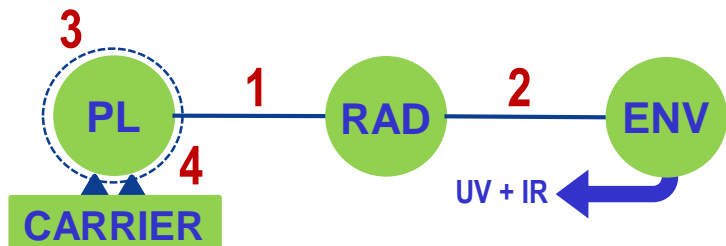
Rover
Lander
Orbiter
Flyer
Airship

Science Payload (PL)
253-313 K

Moon	(100-380 K, Vac)
Mars	(148-293 K, Non-Vac)
Europa	(53-113 K, Vac)
Titan	(90-94 K, Non-Vac)
Io	(105-123 K, Vac)
Venus 70-30 km	(173-473 K, Non-Vac)

Low Power
Lightweight
Passive
Compact
Reliable
Affordable
Radioisotope-Free

Extreme Environment operability/survivability requires 4 improved thermal toolbox elements ...

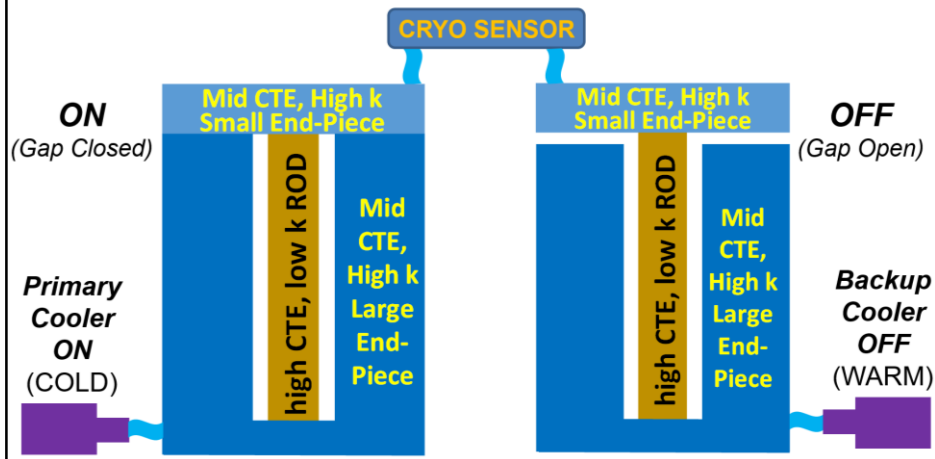


1 – PASSIVE THERMAL SWITCHING

Differential Thermal Expansion (DTE) Actuation

Normal-Operation

For applications that must **KEEP HEAT OUT**, such as a dual cryocooler system or Curiosity SAM, a **Normal-Operation DTE Thermal Switch** has a LOW k ROD with a **Higher CTE** than the HIGH k END-PIECES.

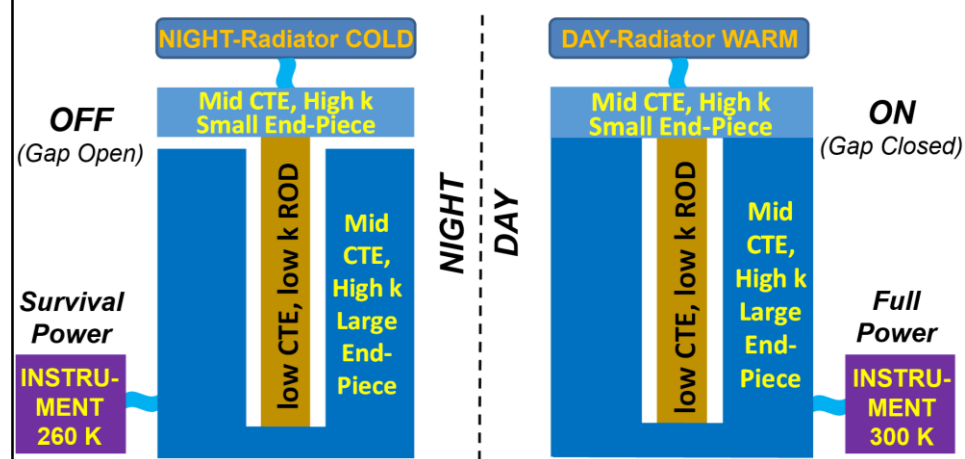


Swales Aerospace 2002

- Flown on Mars Curiosity SAM Instrument in 2012
- SAM thermal switch launched closed at room temp
- Typical normal-op design has open gap at room temp
- Vibration test at JPL in 2016 reduced ON conductance

Reverse-Operation

For applications that must **KEEP HEAT IN**, such as lunar instruments, the new JPL-Developed **Reverse-Operation DTE Thermal Switch** needs a LOW k ROD with a **Lower CTE** than the HIGH k END-PIECES.



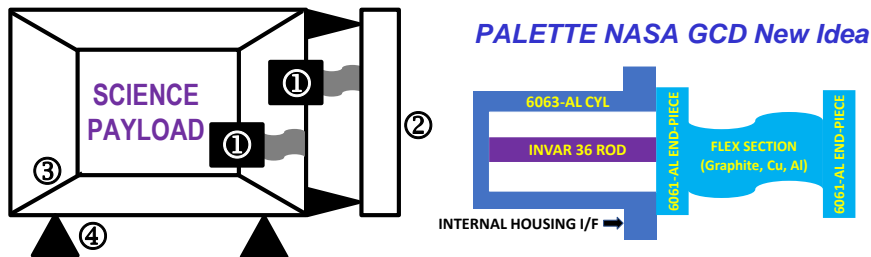
JPL 2017

- Advanced to TRL6 in 2018 (vibe test OK)
- Integral to JPL internal initiative called ARTEMIS
- Integral to NASA GCD Project called **PALETTE**
- Two units to fly on Astrobotic Peregrine lander

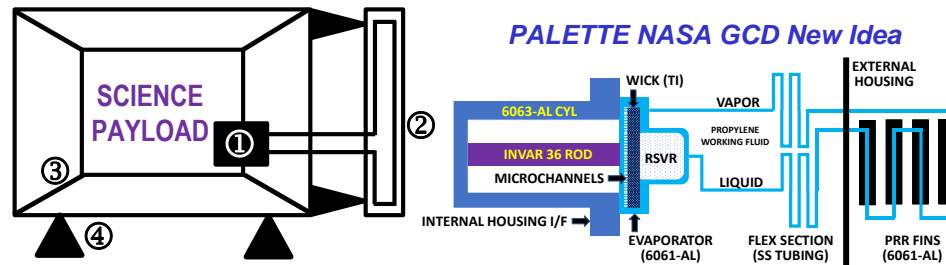
1 – PASSIVE THERMAL SWITCHING (cont'd)

Hyper-Isolative Passive Thermally-Switched Architectures

A. Dual Thermal Switching Enclosure with Reverse-Operation DTE Thermal Switches (ROD-TSWs)



B. Dual Thermal Switching Enclosure with Combined ROD-TSW, Mini Loop Heat Pipe (mini-LHP)



ROD-TSW DESIGN-1: Compact Mounting Flange

Measured Performance

- GON = 5 W/K
- GOFF = 0.002 W/K
- G-Ratio = 2500
- TON/OFF = 273 K

Envelope: L = 126 mm, D (max) = 35 mm
Mass: 137 grams

ROD-TSW DESIGN-2: Heritage Mounting Flange

Measured Performance

- GON = 5 W/K
- GOFF = 0.002 W/K
- G-Ratio = 2500
- TON/OFF = 283 K

Envelope: L = 86 mm, D (max) = 55 mm
Mass: 142 grams

LEGEND

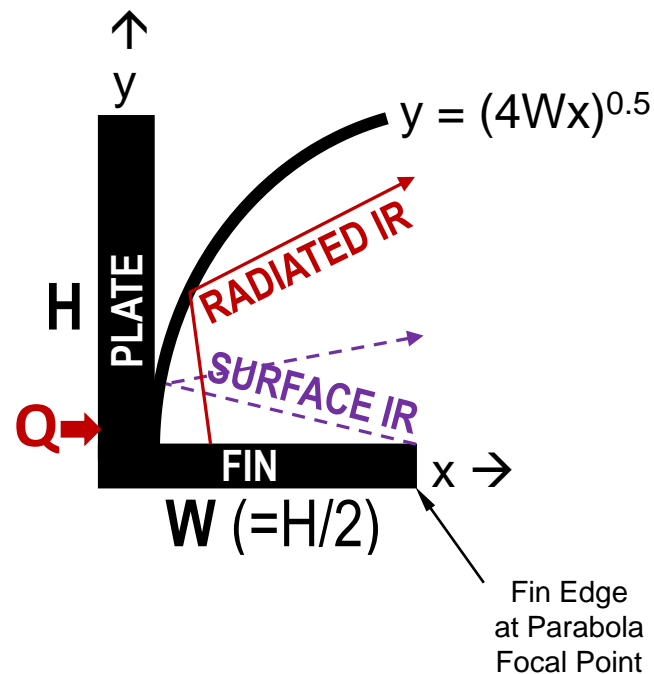
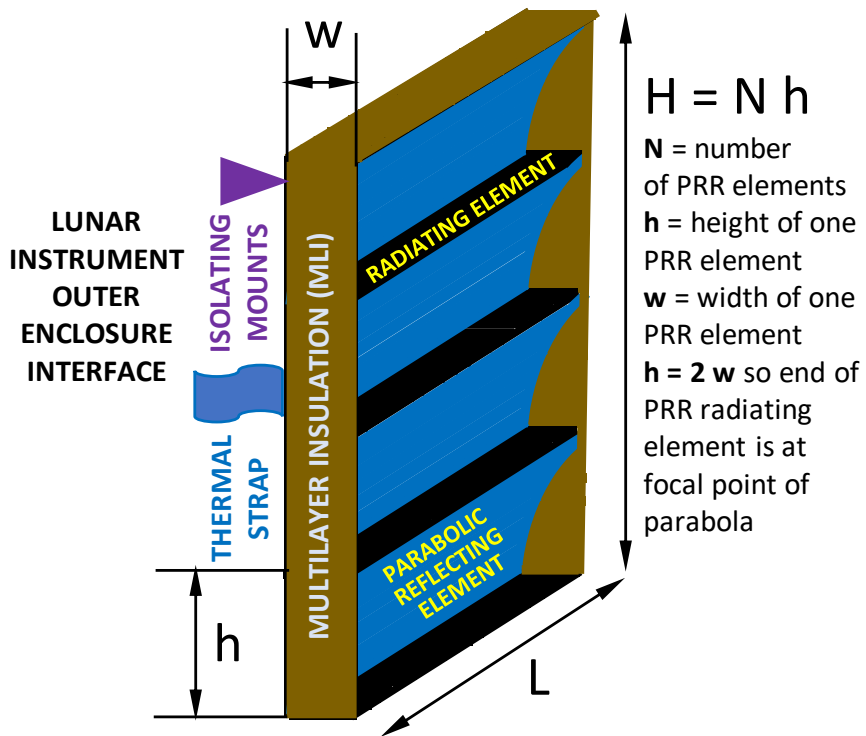
- ① Thermal Switch
- ② Radiator (PRR)*
- ③ Kevlar Cables/MLI*
- ④ Thermal Isolator*

* shown later



2 – LOW SINK TEMP RADIATORS

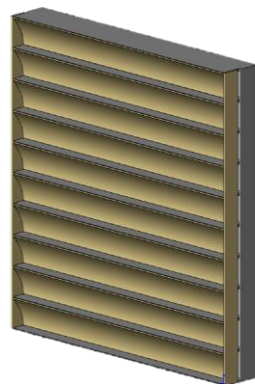
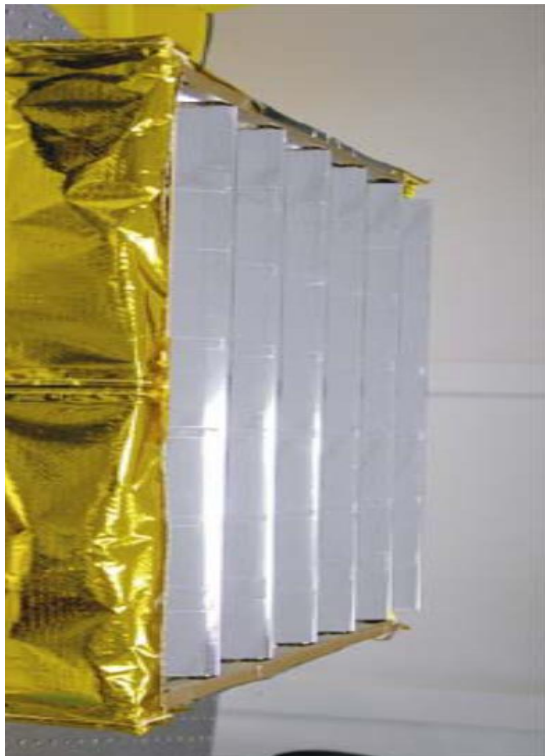
Parabolic Reflector Radiators (PRRs) Provide Low Sink Temperature



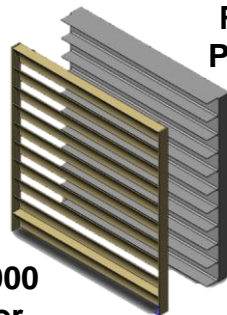
2 – LOW SINK TEMP RADIATORS (cont'd)

3D-Printed PRRs Reduce Fabrication Costs, Provide Low Sink Temp

M3 Cryogenic PRR Cost >> \$100K



2-Piece
Ambient PRR
Design Fully
3D-Printable



Aluminum
Radiator
Plate/Fins

Ultem 1000
Reflector
Array

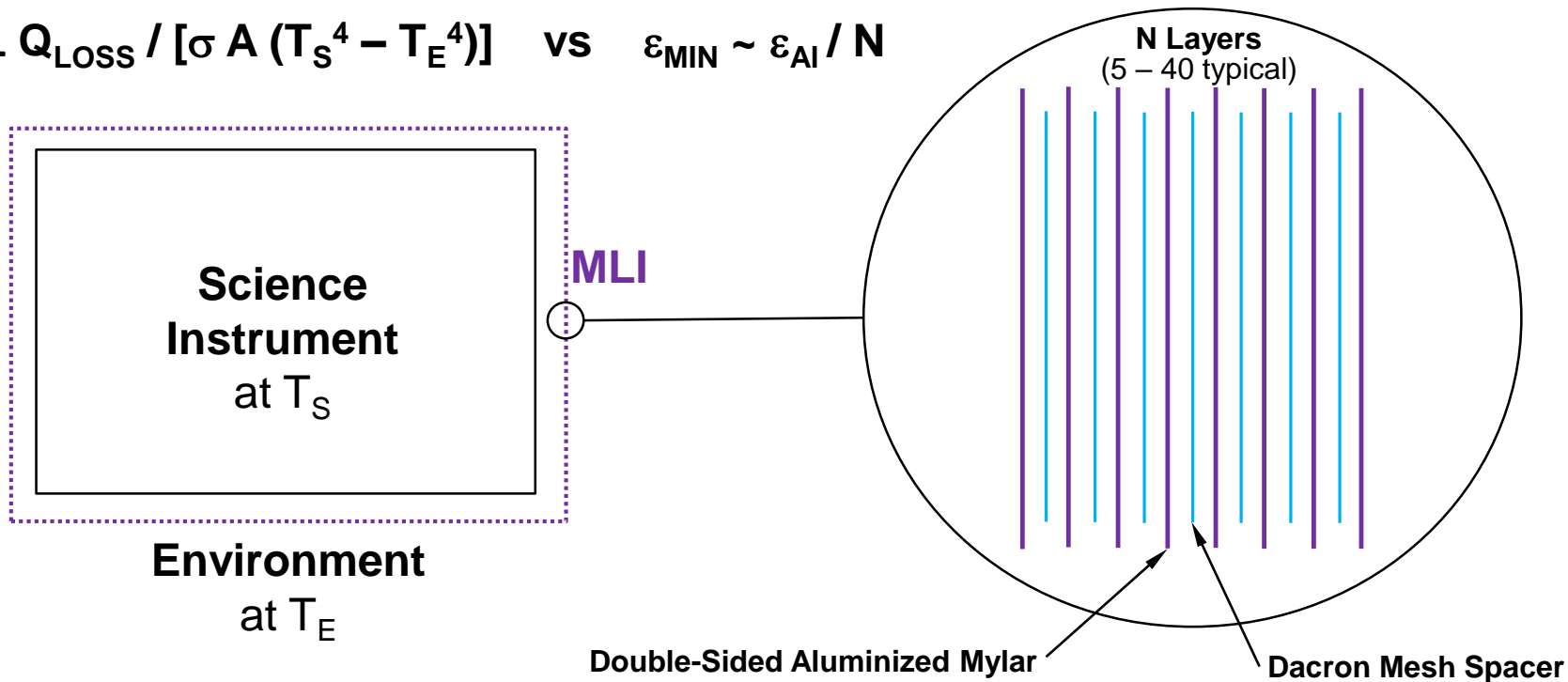
Ambient PRR to Cost << \$20K



3 – LOW EFFECTIVE EMISSIVITY MLI

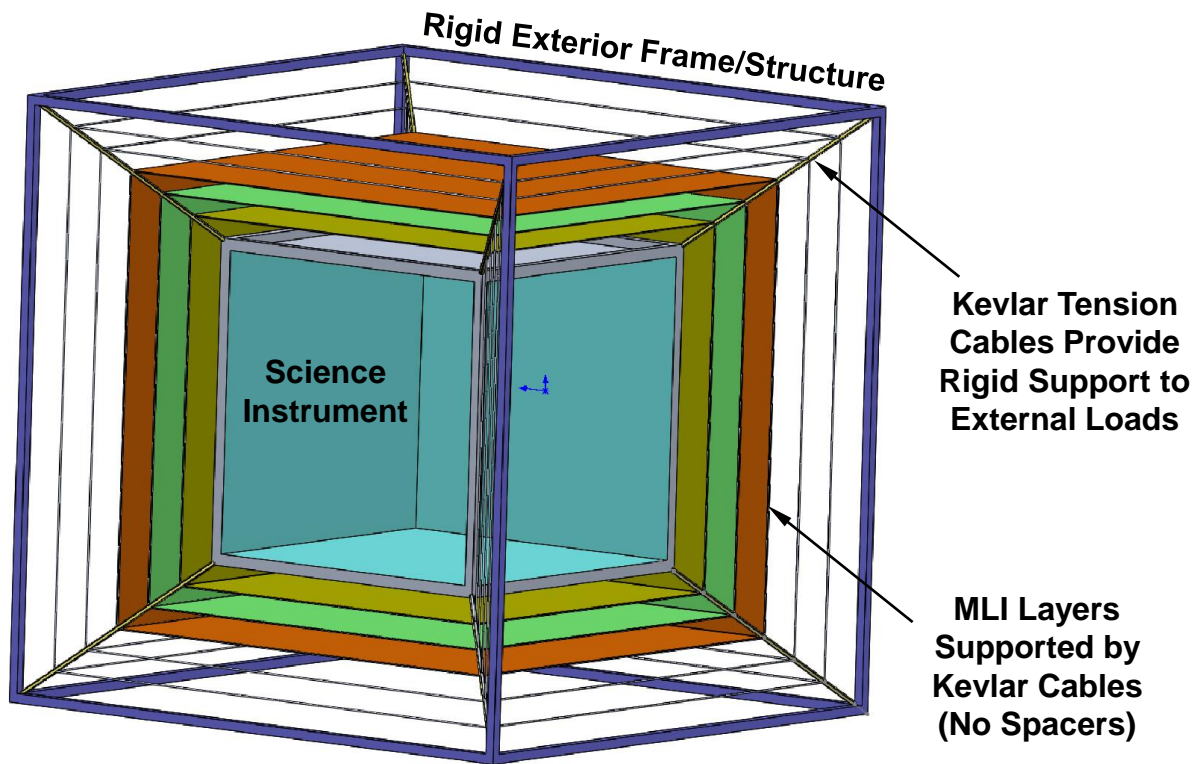
MLI with Spacers Typically has $\epsilon^ \gg 0.02$ despite Al-Mylar $\epsilon_{Al} = 0.03$ on Both Sides*

$$\epsilon^* L Q_{LOSS} / [\sigma A (T_S^4 - T_E^4)] \quad \text{VS} \quad \epsilon_{MIN} \sim \epsilon_{Al} / N$$

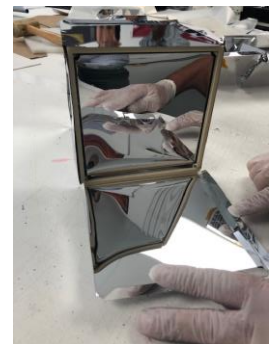
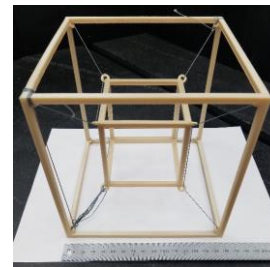


3 – LOW EFFECTIVE EMISSIVITY MLI (cont'd)

“Spacerless” MLI Construction: Performance Target $\epsilon^ \ll 0.01$*



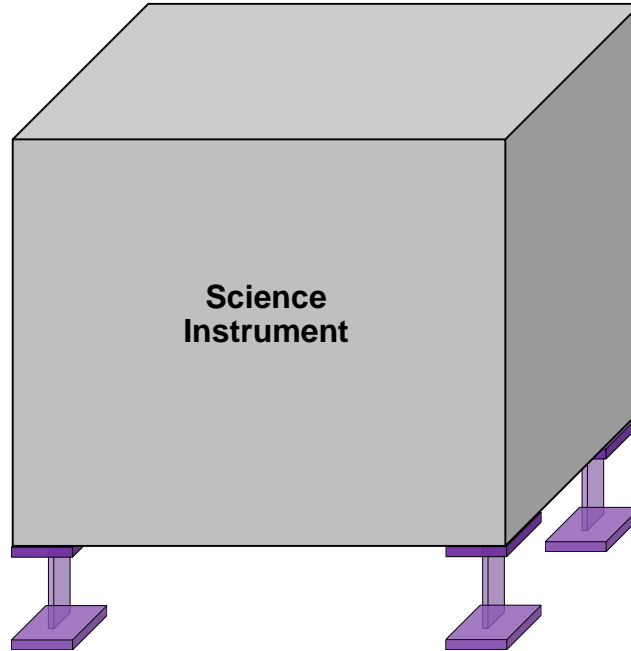
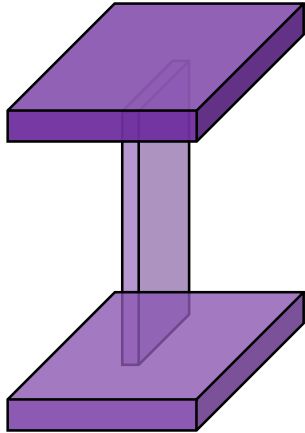
Spacerless MLI Demo Unit to be Tested When JPL Reopens



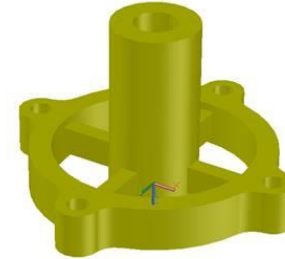
4 – LOW G THERMAL ISOLATORS

Concepts to Outperform Blade Flexures: Performance Target is $G \ll 0.001$ W/K

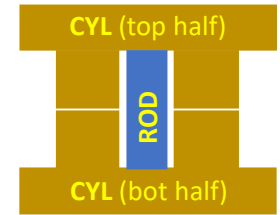
**Notional Metallic
Blade Flexure
Thermal Isolator**



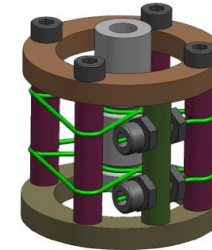
**3D-Printable
Ultem 1000
Thermal Isolator**



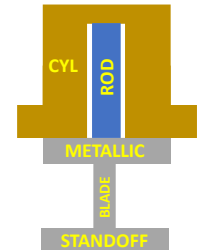
**ROD-TSW Based
Thermal Switching
Isolator Concept 1**



**Kevlar Tension
Cable Supported
Thermal Isolator**



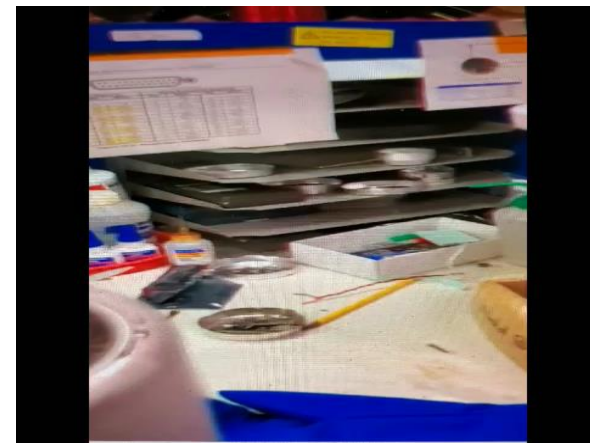
**ROD-TSW Based
Thermal Switching
Isolator Concept 2**



SUMMARY / FUTURE WORK

- Operation and survival in extreme environments like the moon (without radioisotopes) requires an improved thermal toolbox.
- JPL is currently using internal funds to develop thermal enclosure designs for stand-alone solar/battery-powered lunar magnetometers, seismometers, and IR spectrometers.
- In parallel, JPL was recently awarded a 3-year project (PALETTE) by NASA GCD program office to develop advanced thermal toolbox elements for future instruments operating in extreme (planetary/lunar) environments.
- PALETTE intends to provide thermal engineers with a full “palette” of TRL6 or higher thermal toolbox elements, focusing on: 1-enclosures; 2-radiators; 3-insulation/MLI; 4-thermal isolators; 5-gimbals; 6-thermal switches; 7-thermal transport devices; 8-thermal storage devices; 9-deployables/antennae; and 10-low heat loss feed-throughs.
- Work on PALETTE is just getting started and work on the internal JPL program (known as ARTEMIS-T) is midway through the first year of a 3-year project.
- JPL also working on Extended Stroke ROD-TSW for non-vacuum and vacuum environments using DTE between Ultem 1000 and (negative CTE) Allvar ... movie shows large 2 mm gap formed when demo unit partly submerged in LN2

**Extended Stroke ROD-TSW
Demo Unit Creates 2 mm Gap
When Partly Submerged in LN2**
(1-Minute Movie)



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